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RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP: S7G2

DEVICE : R7FS7G2XXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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Table. Reliability test results (QFP)

Test Items Reference		Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$, 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	0/3	Class: Equivalent to C2b
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

^{*1)} With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



Table. Reliability test results (BGA)

Test Items Reference		Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^{\circ}$ to 125 $^{\circ}$, 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	0/3	Class: Equivalent to C2b
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

^{*1)} With preconditioning per JESD22-A113, MSL 3

Note:

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

[•]It is tested to confirm that all the samples are satisfied with an individual product specification.



Table. Reliability test results (LGA)

Test Items Reference		Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 $^{\circ}$ C, RH=85 $^{\circ}$, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^{\circ}$ C to 125 $^{\circ}$ C , 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	0/3	Class: Equivalent to C2b
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

^{*1)} With preconditioning per JESD22-A113, MSL 3

Note:

 $Basically\ qualification\ tests\ were\ performed\ using\ a\ representative\ product\ with\ the\ same\ wafer\ process\ and\ the\ same\ package\ structure\ .$

[•]It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

•Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 0.04 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term (π T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV)
Ta: Ambient temperature (℃)

π T simplified chart as Ea=0.7 eV												
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

·MTTF (Mean Time To Failure)

$$MTTF = 1/\lambda$$



Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

^{*1.} First four digit

Table. Product list

	e. Product		_		_		
No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	S7G2	R7FS7G27G2A01CBD	PLBG0224G*	51			
2	S7G2	R7FS7G27H2A01CBD	PLBG0224G*	52			
3	S7G2	R7FS7G27G2A01CBG	PLBG0176G*	53			
4	S7G2	R7FS7G27H2A01CBG	PLBG0176G*	54			
5	S7G2	R7FS7G27G3A01CFB	PLQP0144K*	55			
6	S7G2	R7FS7G27H3A01CFB	PLQP0144K*	56			
7	S7G2	R7FS7G27G3A01CFC	PLQP0176K*	57			
8	S7G2	R7FS7G27H3A01CFC	PLQP0176K*	58			
9	S7G2	R7FS7G27G3A01CFP	PLQP0100K*	59			
10	S7G2	R7FS7G27G2A01CLK	PTLG0145K*	60			
11	S7G2	R7FS7G27H2A01CLK	PTLG0145K*	61			
12				62			
13				63			
14				64			
15				65			
16				66			
17				67			
18				68			
19				69	+		
20				70			
21				71	+		
22				72			
23				73			
24				74	+	+	
		+			+		
25 26				75 76			
27				77			
28				78			
29				79			
30				80	_		
31				81			
32				82			
33				83			
34				84			
35				85			
36	1			86	+		
37				87			
38				88			
39				89	 		
40	1			90			
41				91	1		
42				92			
43				93			
44				94			
45				95			
46				96			
47				97			
48				98			
49				99	İ		
50				100	1		